Preferred Device

Triacs

Silicon Bidirectional Thyristors

Designed primarily for full-wave ac control applications, such as motor controls, heating controls or dimmers; or wherever full-wave, silicon gate–controlled devices are needed.

- Uniform Gate Trigger Currents in Three Quadrants, Q1, Q2, and Q3
- High Commutating di/dt and High Immunity to dv/dt @ 125°C
- Minimizes Snubber Networks for Protection
- Blocking Voltage to 800 Volts
- On-State Current Rating of 12 Amperes RMS at 80°C
- High Surge Current Capability 100 Amperes
- Industry Standard TO-220AB Package for Ease of Design
- Glass Passivated Junctions for Reliability and Uniformity
- Device Marking: Logo, Device Type, e.g., MAC12HCD, Date Code

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage ⁽¹⁾ ($T_J = -40$ to 125°C, Sine Wave, 50 to 60 Hz, Gate Open)	V _{DRM,} V _{RRM}		Volts
MAC12HCD MAC12HCM MAC12HCN		400 600 800	
On-State RMS Current (All Conduction Angles; T _C = 80°C)	I _{T(RMS)}	12	A
Peak Non-Repetitive Surge Current (One Full Cycle, 60 Hz, T _J = 125°C)	I _{TSM}	100	A
Circuit Fusing Consideration (t = 8.33 ms)	l ² t	41	A ² sec
Peak Gate Power (Pulse Width \leq 1.0 µs, T _C = 80°C)	P _{GM}	16	Watts
Average Gate Power (t = 8.3 ms, $T_C = 80^{\circ}C$)	P _{G(AV)}	0.35	Watts
Operating Junction Temperature Range	ТJ	–40 to +125	°C
Storage Temperature Range	T _{stg}	–40 to +150	°C

(1) V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

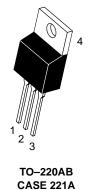


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TRIACS 12 AMPERES RMS 400 thru 800 VOLTS





STYLE 4

	PIN ASSIGNMENT
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

ORDERING INFORMATION

Device	Package	Shipping
MAC12HCD	TO220AB	50 Units/Rail
MAC12HCM	TO220AB	50 Units/Rail
MAC12HCN	TO220AB	50 Units/Rail

Preferred devices are recommended choices for future use and best overall value.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance			°C/W
— Junction to Case	$R_{\theta JC}$	2.2	
— Junction to Ambient	$R_{\theta JA}$	62.5	
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C

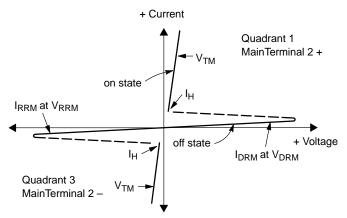
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted; Electricals apply in both directions)

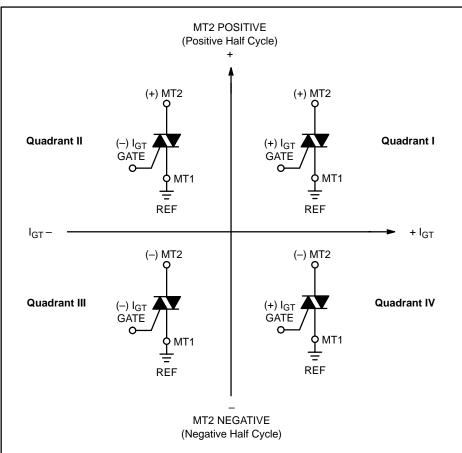
Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					•	•
Peak Repetitive Blocking Current ($V_D = Rated V_{DRM}, V_{RRM}$, Gate Open)	T _J = 25°C T _J = 125°C	I _{DRM} , I _{RRM}			0.01 2.0	mA
ON CHARACTERISTICS						
Peak On-State Voltage ⁽¹⁾ ($I_{TM} = \pm 17 A$)		V _{TM}	_	_	1.85	V
Gate Trigger Current (Continuous dc) ($V_D = 12 V$, $R_L = 1$ MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)	100 Ω)	I _{GT}	10 10 10		50 50 50	mA
Holding Current ($V_D = 12 V$, Gate Open, Initiating Current = ±150 mA)			_	_	60	mA
Latch Current (V_D = 12 V, I_G = 50 mA) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)					60 80 60	mA
Gate Trigger Voltage (Continuous dc) ($V_D = 12 V$, $R_L = 100 \Omega$) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)			0.5 0.5 0.5		1.5 1.5 1.5	V
DYNAMIC CHARACTERISTICS						
Rate of Change of Commutating Current (V _D = 400 V, I _{TM} = 4.4 A, Commutating dv/dt = 18 V/ μ s, Gate Open, T _J = 125°C, f = 250 Hz, C _L = 10 μ F, L _L = 40 mH, with Snubber)			15	_	_	A/ms
Critical Rate of Rise of Off-State Voltage (V_D = Rated V_{DRM} , Exponential Waveform, Gate Open, T_J = 125°C)		dv/dt	600	_	_	V/µs
Repetitive Critical Rate of Rise of On-State Current IPK = 50 A; PW = 40 μsec; diG/dt = 200 mA/μsec; f = 60 Hz			_	_	10	A/µs

(1) Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

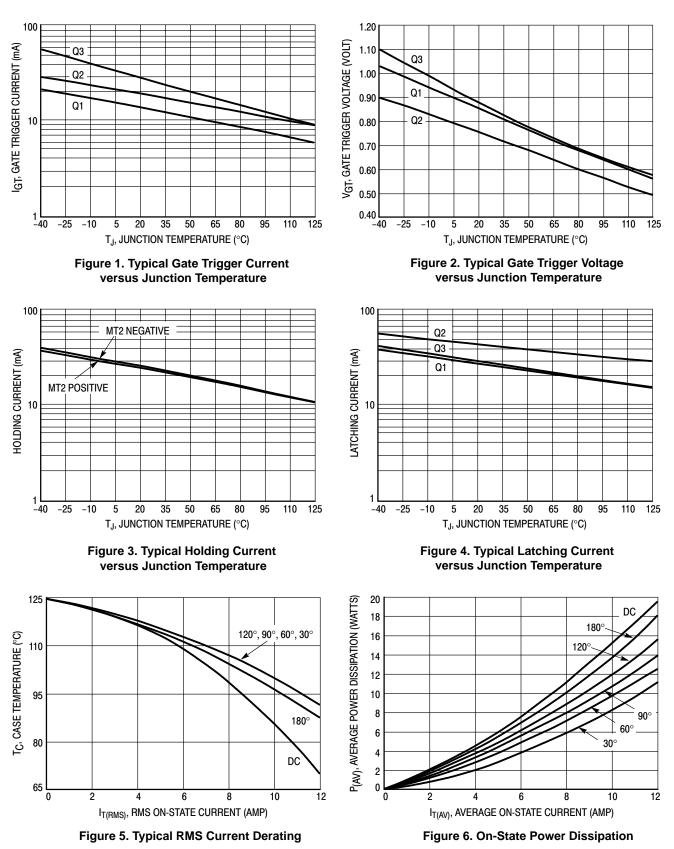




Quadrant Definitions for a Triac

All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.



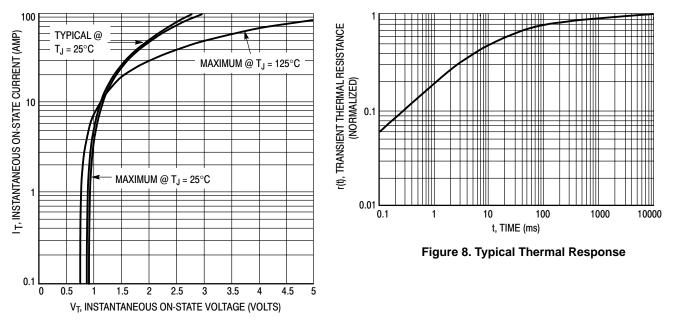
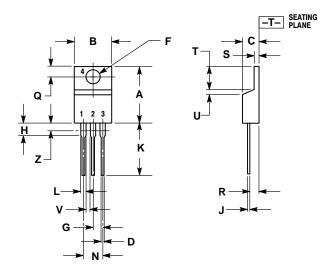


Figure 7. Typical On-State Characteristics

PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AA**



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALI OWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN MAX	
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
Κ	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Ζ		0.080		2.04

STYLE 4: PIN 1. MAIN TERMINAL 1 2. MAIN TERMINAL 2 3. GATE 4. MAIN TERMINAL 2

<u>Notes</u>

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